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| MDCOG128128B6W-FPTLW | | 128 | | LCD Module | | |
|----------------------|-----------|------------|-----------------|------------|--|--|
| Specification | | | | | | |
| Version: 1 | | | Date: 03/01/202 | 0 | | |
| | | Revisio | า | | | |
| 1 30/* | 12/2019 F | irst Issue | | | | |
| | | | | | | |

| Display F | Display Features | | | | |
|-----------------------|------------------------|--------------|------------------|--|--|
| Resolution | 128 x 128 | | | | |
| Appearance | Black on White | | | | |
| Logic Voltage | 3V | | | | |
| Interface | Multi | | CoHS | | |
| Font Set | N/A | | ompliant | | |
| Display Mode | Transflective | | mphant | | |
| LC Туре | FSTN | | | | |
| Module Size | 55.00 x 57.00 x 6.18mm | YD | | | |
| Operating Temperature | -20°C ~ +70°C | | | | |
| Construction | COG | Box Quantity | Weight / Display | | |
| LED Backlight | White | | | | |

* - For full design functionality, please use this specification in conjunction with the ST75161 specification. (Provided Separately)

| Display Accessories | | | | |
|-------------------------|--|--|--|--|
| Part Number Description | | | | |
| | | | | |
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| Optional Variants | | | | |
|-------------------|---------|--|--|--|
| Appearances | Voltage | | | |
| | | | | |
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General Specification

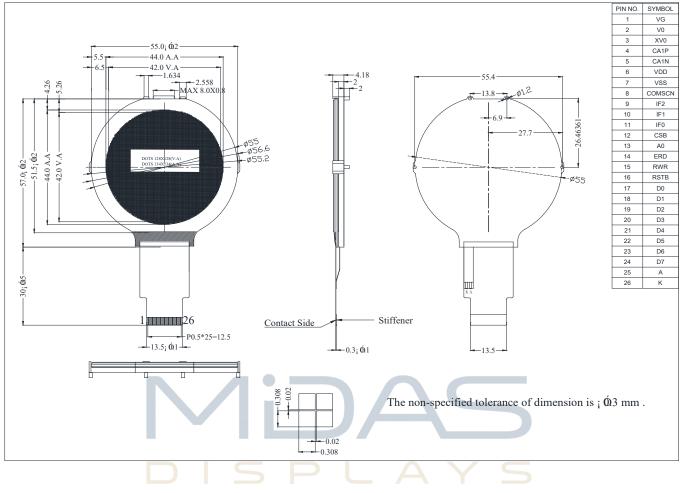
The Features of the Module is description as follow:

- Number of dots: 128 x 128
- Module dimension: 55.0 x 57.0 x 6.18 mm
- View area: 42.0 x 42.0 mm
- Active area: 44.0 x 44.0 mm
- Dot size: 0.308 x 0.308 mm
- Dot pitch: 0.310 x 0.310 mm
- LCD type: FSTN Positive Transflective
- Duty: 1/136 DUTY,1/12 BIAS
- View direction: 6 o'clock
- Backlight Type: LED White MANUFACTURE . SUPPLY
- IC: ST75161

Interface Pin Function

| Pin No. | SYMBOL | Function |
|---------|--------|--|
| 1 | VG | VG is the power of SEG-drivers. |
| 2 | V0 | Positive operating voltage of COM-drivers. |
| 3 | XV0 | Negative operating voltage of COM-drivers. |
| 4 | CA1P | DC/DC voltage converter |
| 5 | CA1N | |
| 6 | VDD | Power supply |
| 7 | VSS | Ground |
| 8 | COMSCN | Set scan direction of COM. |
| 9 | IF2 | |
| 10 | IF1 | These pins select interface operation mode. |
| 11 | IF0 | |
| 12 | CSB | Chip select input pin. |
| 13 | A0 | It determines whether the access is related to data or command. |
| 14 | ERD | Read / Write execution control pin. |
| 15 | RWR | Read / Write execution control pin. |
| 16 | RSTB | Hardware reset input pin |
| 17-24 | | When using 8-bit parallel interface: 8080 or 6800 mode:8 bit bi-directional data bus When using serial interface : 4-line SPI or 3-line SPI mode D[7:4] : fix to "H" by VDD1. D[3:1] : serial input/output data (SDA). D[0] : serial input clock (SCL). D1 to D3 must be connected together (SDA) When using serial interface : I2C interface D[7] : SA[1], I2C slave address bit. Must be connected to VDD1 or VSS1. D[6] : SA[0], I2C slave address bit. Must be connected to VDD1 or VSS1. D[5:4] : fix to "H" by VDD1. D[3:2] : SDA_OUT, serial data and acknowledge output for the I2C interface. D[1] : SDA_IN, serial input data D[0] : SCL, serial input clock . D1 to D3 must be connected together (SDA) |
| 25 | А | Anode input for LED backlight. |
| 26 | К | Cathode input for LED backlight |

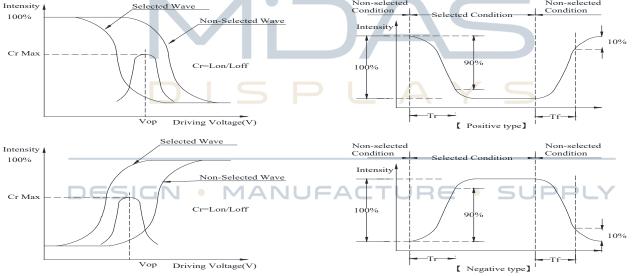
Contour Drawing



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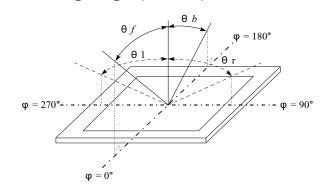
Optical Characteristics

| ltem | Symbol | Condition | Min | Тур | Max | Unit |
|---|--------|-----------|-----|-----|-----|---------|
| View Angle | θ | CR≧2 | 25 | 30 | _ | ψ= 180° |
| | θ | CR≧2 | 35 | 40 | _ | ψ= 0° |
| | θ | CR≧2 | 35 | 40 | _ | ψ= 90° |
| | θ | CR≧2 | 25 | 30 | | ψ= 270° |
| Contrast Ratio | CR | _ | 3 | 4 | _ | — |
| | T rise | _ | | 150 | 225 | ms |
| Response Time | T fall | _ | | 220 | 330 | ms |
| Definition of Operation Voltage (Vop) Definition of Response Time (Tr | | | | • • | | |



Conditions :

Operating Voltage : Vop Viewing Angle(θ , ϕ) : 0°, 0° Frame Frequency : 64 HZ Driving Waveform : 1/N duty, 1/a bias **Definition of viewing angle(CR \geq 2)**



Absolute Maximum Ratings

| Item | Symbol | Min | Тур | Мах | Unit |
|--------------------------|-----------------|------|-----|---------|------|
| Operating Temperature | Тор | -20 | _ | +70 | °C |
| Storage Temperature | T _{ST} | -30 | _ | +80 | °C |
| Power Supply Voltage | VDD | -0.3 | — | 4.0 | V |
| LCD Power supply voltage | VLCD | -0.3 | _ | 20 | V |
| LCD Power supply voltage | V0-XV0 | -0.3 | _ | 19 | V |
| Input voltage | VIN | -0.3 | | VDD+0.3 | V |

Electrical Characteristics

| ltem | Symbol | Condition | Min. | Тур. | Max. | Unit |
|--------------------------|----------------------------------|-----------------------|---------------------|------|---------------------|------|
| Supply Voltage For Logic | V _{DD} -V _{SS} | _ | 2.7 | 3.0 | 3.3 | V |
| DESIGN . | MAN | Ta=-20℃ | JRĒ • | SUP | | V |
| Supply Voltage For LCD | Vop | Ta=25 ℃ | 13.7 | 14.0 | 14.3 | V |
| | | Ta=70 ℃ | _ | _ | _ | V |
| Input High Volt. | VIH | _ | 0.7 V _{DD} | _ | Vdd | V |
| Input Low Volt. | VIL | _ | Vss | _ | 0.3 V _{DD} | V |
| Output High Volt. | Vон | _ | 0.8 V _{DD} | _ | V _{DD} | V |
| Output Low Volt. | Vol | _ | Vss | _ | 0.2 V _{DD} | V |
| Supply Current | Idd | V _{DD} =3.0V | _ | | 2.0 | mA |

Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance.

Backlight Information

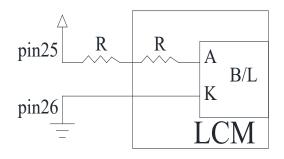
Specification

| PARAMETER | SYMBOL | MIN | ТҮР | MAX | UNIT | TEST CONDITION |
|-----------------|--------|------|------|------|-------------------|----------------|
| Supply Current | ILED | 36 | 48 | 60 | mA | V=3.5V |
| Supply Voltage | V | _ | 3.5 | _ | v | _ |
| Reverse Voltage | VR | _ | _ | 5 | v | _ |
| Chromaticity | X | 0.25 | 0.27 | 0.30 | _ | _ |
| Coordinates | Y | 0.25 | 0.27 | 0.30 | _ | _ |
| Luminance | N7 | | 4000 | | a d <i>l</i> /ma? | V-2 5V |
| (Without LCD) | IV | 800 | 1000 | _ | ca/m- | V=3.5V |
| LED Life Time | | | | | | ILED=48mA |
| (For Reference | _ | _ | 50K | | Hr. | 25℃,50-60%RH, |
| only) | D | S | | | Α | (Note 1) |
| Color | White | | | | | |

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1:50K hours is only an estimate for reference.

Drive from pin25,pin26



Reliability

Content of Reliability Test (Wide temperature, -20℃~70℃)

| | Environmental Test | | | | | | |
|---------------------------------------|---|---|----------|--|--|--|--|
| Test Item | Content of Test | Test Condition | Not e | | | | |
| High Temperature storage | Endurance test applying the high storage temperature for a long time. | 80℃ 96hrs | 2 | | | | |
| Low Temperature storage | Endurance test applying the low storage temperature for a long time. | -30℃ 96hrs | 1,2 | | | | |
| High Temperature Operation | Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time. | 70℃ 96hrs | | | | | |
| Low Temperature Operation | Endurance test applying the electric stress under low temperature for a long time. | -20℃ 96hrs | 1 | | | | |
| High Temperature/ Humidity storage | The module should be allowed to stand at 40 $^{\circ}$,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature. | 40℃,90%RH 96hrs | 1,2 | | | | |
| Thermal shock resistance | The sample should be allowed stand the following 10 cycles of operation $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | -20℃/70℃ 10 cycles | | | | | |
| DESIG | | Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes | 3 | | | | |
| Static electricity test | Endurance test applying the electric stress to the terminal. | VS=±600V(contact) | | | | | |

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

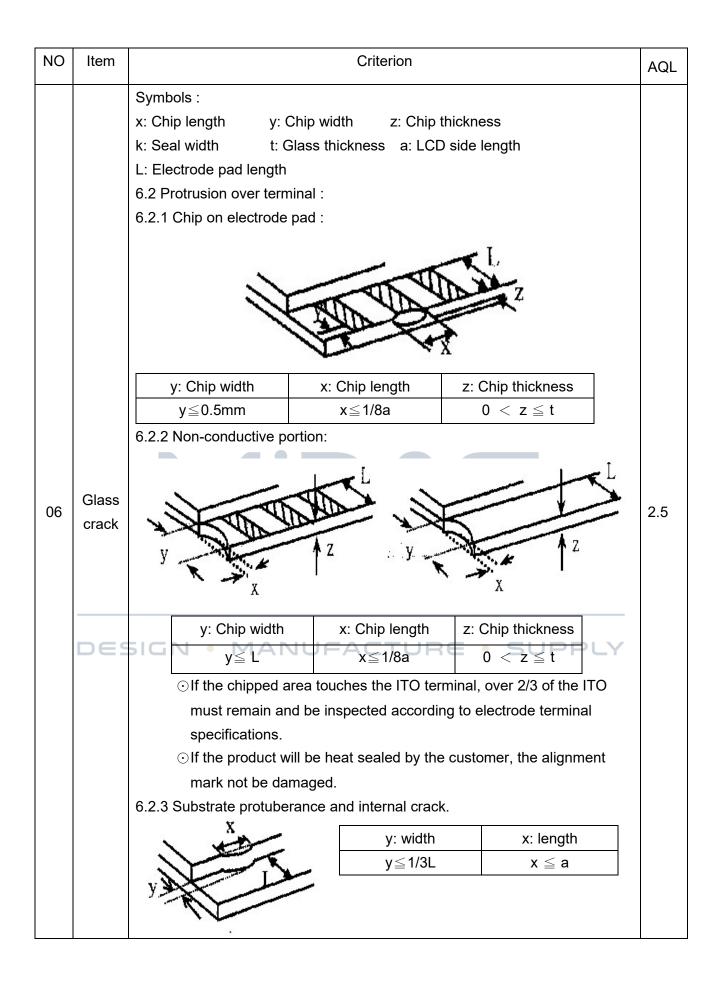
Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

Inspection specification

| NO | Item | | Criterion | | AQL |
|----|---|---|---|--|------|
| 01 | Electrical Testing | 1.1 Missing vertical, horizodefect. 1.2 Missing character, doi: 1.3 Display malfunction. 1.4 No function or no displication. 1.5 Current consumption et al. 1.6 LCD viewing angle defined. 1.7 Mixed product types. 1.8 Contrast defect. | t or icon. lay. exceeds product sp | | 0.65 |
| 02 | Black or white spots on LCD (display only) | 2.1 White and black spotsthree white or black sp2.2 Densely spaced: No m | ots present. | | 2.5 |
| 03 | LCD black spots, white spots, contamination (non-display) | | $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$ | Acceptable Q TY Accept no dense 2 1 5 0 Acceptable Q TY Accept no dense 2 As round type | 2.5 |
| 04 | Polarizer bubbles | If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction. | Size Φ $\Phi \leq 0.20$ $0.20 < \Phi \leq 0.50$ $0.50 < \Phi \leq 1.00$ $1.00 < \Phi$ Total Q TY | Acceptable Q TY Accept no dense 3 2 0 3 | 2.5 |

| NO | Item | | Criterion | | AQL |
|----|-----------|---|---|-------------------------------------|-----|
| 05 | Scratches | Follow NO.3 LCD black | spots, white spots, cont | amination | |
| | | k: Seal width t: CL: Electrode pad length6.1 General glass chip | | side length | |
| 06 | Chipped | $\frac{x}{z: Chip thickness}$ | y: Chip width Not over viewing area | $\frac{x: Chip length}{x \le 1/8a}$ | 2.5 |
| | glass | $1/2t < z \le 2t$ | Not exceed 1/3k | x≦1/8a | 2.0 |
| | DESIG | Olf there are 2 or more 6.1.2 Corner crack: N ● MAN | chips, x is total length o | f each chip. Y SUPPLY | |
| | | z: Chip thickness | y: Chip width | x: Chip length | |
| | | Z≦1/2t | Not over viewing area | x≦1/8a | |
| | | $1/2t < z \leq 2t$ | Not exceed 1/3k | x≦1/8a | |
| | | \odot If there are 2 or more | chips, x is the total leng | th of each chip. | |



| NO | Item | Criterion | AQL | | | | | |
|----|-----------------------|---|-------------|--|--|--|--|--|
| 07 | Cracked glass | The LCD with extensive crack is not acceptable. | | | | | | |
| 08 | Backlight elements | 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. | | | | | | |
| 09 | Bezel | 9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications. | | | | | | |
| 10 | | 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height | 2.5 | | | | | |
| | PCB · COB | indicated in the assembly diagram. | 0.65 | | | | | |
| | | 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. | 2.5 | | | | | |
| | | 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. | 2.5 0.65 | | | | | |
| | | 10.7 The jumper on the PCB should conform to the product characteristic chart. ACTURE • SUPPL 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. | 0.65 | | | | | |
| | | 10.9 The Scraping testing standard for Copper Coating of PCB | 2.5 | | | | | |
| | | X X * Y<=2mm2 | 2.5 | | | | | |
| 11 | Soldering | 11.1 No un-melted solder paste may be present on the PCB.11.2 No cold solder joints, missing solder connections, oxidation or icicle. | 2.5 2.5 | | | | | |
| | | 11.3 No residue or solder balls on PCB. | | | | | | |
| | | 11.4 No short circuits in components on PCB. | 0.65 | | | | | |

| NO | Item | Criterion | AQL | | | | |
|----|-----------------------|--|------|--|--|--|--|
| | General appearance | 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. | | | | | |
| | | 12.2 No cracks on interface pin (OLB) of TCP. | | | | | |
| | | 12.3 No contamination, solder residue or solder balls on product. | | | | | |
| | | 12.4 The IC on the TCP may not be damaged, circuits.12.5 The uppermost edge of the protective strip on the interface | | | | | |
| | | | | | | | |
| | | pin must be present or look as if it cause the interface pin to | | | | | |
| | | sever. | | | | | |
| 12 | | 12.6 The residual rosin or tin oil of soldering (component or chip | | | | | |
| | | component) is not burned into brown or black color. | | | | | |
| | | 12.7 Sealant on top of the ITO circuit has not hardened.12.8 Pin type must match type in specification sheet.12.9 LCD pin loose or missing pins. | | | | | |
| | | | | | | | |
| | | | | | | | |
| | | 12.10 Product packaging must the same as specified on | 0.65 | | | | |
| | | packaging specification sheet. | | | | | |
| | | 12.11 Product dimension and structure must conform to product | 0.65 | | | | |
| | | specification sheet. | | | | | |
| | | 12.12 Visual defect outside of VA is not considered to be rejection. | | | | | |

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Precautions in use of LCD Modules

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Midas have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors,capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Midas have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Midas have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

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Material List of Components for RoHs

1.Midas Displays hereby declares that all of or part of products (with the mark

"#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A : The Harmful Material List

| Material | Cd | Pb | Hg | Cr6+ | PBB | PBDE | DEHP | BBP | DBP | DIBP | |
|--|-----|------|------|------|------|------|------|------|------|------|--|
| Limited | 100 | 1000 | 1000 | 1000 | 1000 | 1000 | 1000 | 1000 | 1000 | 1000 | |
| Value | ppm | ppm | ppm | ppm | ppm | ppm | ppm | ppm | ppm | ppm | |
| Above limited value is set up according to RoHS. | | | | | | | | | | | |

- 2.Process for RoHS requirement : (only for RoHS inspection)
 - (1) Use the Sn/Ag/Cu soldering surface ; the surface of Pb-free solder is rougher than we used before.
 - (2) Heat-resistance temp. :

Reflow : 250°C,30 seconds Max. ;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°C ;

Recommended customer's soldering temp. of connector : 280°C, 3 seconds.

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Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.